# EDL Series, +85°C



### **Overview**

KEMET's EDL Series of aluminum electrolytic surface mount capacitors are designed for high density printed circuit boards.

# **Applications**

Typical applications include audio/visual (AV), computer/ monitor and communications.

### **Benefits**

- · Surface mount lead terminals
- · Low profile vertical chip
- 85°C/3,000 5,000 hours

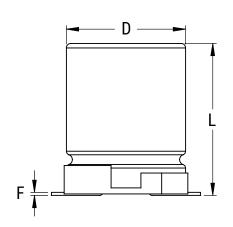


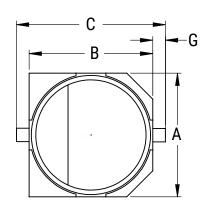
# **Part Number System**

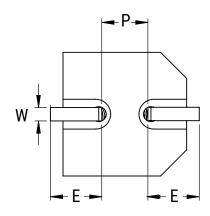
EDL	226	M	004		Α	9B	AA
Series	Capacitance Code (pF)	Tolerance	Rated Voltage (VDC)		Electrical Parameters	Size Code	Packaging
Surface Mount Aluminum Electrolytic	First two digits represent significant figures for capacitance values. Last digit specifies the number of zeros to be added.	M = ±20%	004 = 4 6R3 = 6.3 010 = 10 016 = 16 025 = 25	035 = 35 050 = 50 063 = 63 100 = 100	A = Standard	See Dimension Table	AA = Tape & Reel



# **Dimensions - Millimeters**







Size Code	D		L		A/B		С		E	
	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
9B	4	±0.5	5.4	+0.25/-0.1	4.3	±0.2	5.5	Maximum	1.8	±0.2
9D	5	±0.5	5.4	+0.25/-0.1	5.3	±0.2	6.5	Maximum	2.2	±0.2
9G	6.3	±0.5	5.4	+0.25/-0.1	6.6	±0.2	7.8	Maximum	2.6	±0.2
9H	6.3	±0.5	7.7	±0.3	6.6	±0.2	7.8	Maximum	2.6	±0.2
9M	8	±0.5	10.2	±0.3	8.3	±0.2	10	Maximum	3.4	±0.2
9P	10	±0.5	10.2	±0.3	10.3	±0.2	13	Maximum	3.5	±0.2

Size Code	F		G		Р		W	
	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
9B	0.3	Maximum	0.35	+0.15/-0.2	1.0	±0.2	0.65	±0.1
9D	0.3	Maximum	0.35	+0.15/-0.2	1.5	±0.2	0.65	±0.1
9G	0.3	Maximum	0.35	+0.15/-0.2	1.8	±0.2	0.65	±0.1
9H	0.3	Maximum	0.35	+0.15/-0.2	1.8	±0.2	0.65	±0.1
9M	0.3	Maximum	0.70	±0.2	3.1	±0.2	0.9	±0.2
9P	0.3	Maximum	0.70	±0.2	4.6	±0.2	0.9	±0.2



### **Environmental Compliance**

As an environmentally conscious company, KEMET is working continuously with improvements concerning the environmental effects of both our capacitors and their production. In Europe (RoHS Directive) and in some other geographical areas like China, legislation has been put in place to prevent the use of some hazardous materials, such as lead (Pb), in electronic equipment. All products in this catalog are produced to help our customers' obligations to guarantee their products and fulfill these legislative requirements. The only material of concern in our products has been lead (Pb), which has been removed from all designs to fulfill the requirement of containing less than 0.1% of lead in any homogeneous material. KEMET will closely follow any changes in legislation world wide and makes any necessary changes in its products, whenever needed.

Some customer segments such as medical, military and automotive electronics may still require the use of lead in electrode coatings. To clarify the situation and distinguish products from each other, a special symbol is used on the packaging labels for RoHS compatible capacitors.

Because of customer requirements, there may appear additional markings such as LF = Lead Free or LFW = Lead Free Wires on the label.

### **Performance Characteristics**

ltem	Performance Characteristics
Capacitance Range	1 – 1,000 μF
Rated Voltage	4 - 100 VDC
Operating Temperature	-40°C to +85°C
Capacitance Tolerance	±20% at 120 Hz/20°C
Life Test	3,000 – 5,000 hours (see conditions in Test Method & Performance)
	I ≤ 0.01 CV or 3 μA, whichever is greater
Leakage Current	C = rated capacitance (μF), V = rated voltage (VDC). Voltage applied for 2 minutes at 20°C.

# **Impedance Z Characteristics at 120 Hz**

Rated Voltage (VDC)	4	6	10	16	25	35	50	63	100
Z (-25°C)/Z (20°C)	7	4	3	2	2	2	2	2	2
Z (-40°C)/Z (20°C)	15	8	6	4	4	3	3	3	3

## **Compensation Factor of Ripple Current (RC) vs. Frequency**

Rated Voltage (VDC)	60 Hz	120 Hz	1 kHz	10 kHz
Coefficient	0.80	1.00	1.15	1.25



### **Test Method & Performance**

Conditions	Load Li	fe Test	Shelf Life Test		
Temperature	85	85°C			
Test Duration	Can Ø = 4, 5, 6.3 mm 3,000 hours		1,000 hours		
	Can Ø = 8, 10 mm 5,000 hours				
Ripple Current	Maximum ripple current	No ripple current applied			
Voltage	The sum of DC voltage and the pea rated voltage o	No voltage applied			
Performance	The following specification	s will be satisfied when the ca	pacitor is restored to 20°C:		
Capacitance Change	Within ±20% of the initial value				
Dissipation Factor	Does not exceed 200% of the specified value				
Leakage Current	Does not exceed specified value				

#### Shelf Life

The capacitance, ESR and impedance of a capacitor will not change significantly after extended storage periods, however the leakage current will very slowly increase.

KEMET's E-series aluminum electrolytic capacitors should not be stored in high temperatures or where there is a high level of humidity.

The suitable storage condition for KEMET's E-series aluminum electrolytic capacitors is +5 to +35°C and less than 75% in relative humidity.

KEMET's E-series aluminum electrolytic capacitors should not be stored in damp conditions such as water, saltwater spray or oil spray.

KEMET's E-series aluminum electrolytic capacitors should not be stored in an environment full of hazardous gas (hydrogen sulphide, sulphurous acid gas, nitrous acid, chlorine gas, ammonium, etc.)

KEMET's E-series aluminum electrolytic capacitors should not be stored under exposure to ozone, ultraviolet rays or radiation.

If a capacitor has been stored for more than 18 months under these conditions and it shows increased leakage current, then a treatment by voltage application is recommended.

## Re-age (Reforming) Procedure

Apply the rated voltage to the capacitor at room temperature for a period of one hour, or until the leakage current has fallen to a steady value below the specified limit. During re-aging a maximum charging current of twice the specified leakage current or 5 mA (whichever is greater) is suggested.



**Table 1 – Ratings & Part Number Reference** 

				D.F.		1.0	
		Rated		DF	RC	LC	
VDC	VDC Surge	Capacitance	Case Size	120 Hz	120 Hz	20°C	Part Number
V D C	Voltage		D x L (mm)	20°C (tan		2 Minutes	1 di Civalibei
		120 Hz 20°C (μF)	, , ,	δ %)	85°C (mA)	(μΑ)	
4	5	22	4 x 5.4	35	19	3.0	EDL226M004A9BAA
4	5	33	4 x 5.4	35	26	3.0	EDL336M004A9BAA
4	5	47	4 x 5.4	35	34	3.0	EDL476M004A9BAA
4 4	5 5	100	5 x 5.4	35 35	61 82	4.0	EDL107M004A9DAA
6.3	8	220 22	6.3 x 5.4 4 x 5.4	26	20	8.8 3.0	EDL227M004A9GAA EDL226M6R3A9BAA
6.3	8	33	5 x 5.4	26	22	3.0	EDL336M6R3A9DAA
6.3	8	47	5 x 5.4	26	46	3.0	EDL476M6R3A9DAA
6.3	8	100	6.3 x 5.4	26	71	6.3	EDL107M6R3A9GAA
6.3	8	220	6.3 x 7.7	35	250	13.9	EDL227M6R3A9HAA
6.3	8	330	6.3 x 7.7	35	300	20.8	EDL337M6R3A9HAA
6.3	8 8	470	8 x 10.2 10 x 10.2	35 35	380	29.6	EDL477M6R3A9MAA
6.3 10	13	1000 22	4 x 5.4	30	700 28	63.0 3.0	EDL108M6R3A9PAA EDL226M010A9BAA
10	13	33	4 x 5.4	30	29	3.3	EDL336M010A9BAA
10	13	33	5 x 5.4	20	43	3.3	EDL336M010A9DAA
10	13	47	5 x 5.4	30	43	4.7	EDL476M010A9DAA
10	13	100	6.3 x 5.4	26	70	10.0	EDL107M010A9GAA
10	13	220	6.3 x 7.7	26	250	22.0	EDL227M010A9HAA
10 10	13 13	330 470	8 x 10.2 10 x 10.2	26 26	330 400	33.0 47.0	EDL337M010A9MAA EDL477M010A9PAA
10	13	1000	10 x 10.2	26	580	100.0	EDL108M010A9PAA
16	20	4.7	4 x 5.4	16	20	3.0	EDL475M016A9BAA
16	20	10	4 x 5.4	16	28	3.0	EDL106M016A9BAA
16	20	22	4 x 5.4	26	27	3.5	EDL226M016A9BAA
16	20	22	5 x 5.4	16	39	3.5	EDL226M016A9DAA
16	20	33	5 x 5.4	26	45	5.3 5.3	EDL336M016A9DAA
16 16	20 20	33 47	6.3 x 5.4 6.3 x 5.4	16 16	66 70	7.5	EDL336M016A9GAA EDL476M016A9GAA
16	20	100	6.3 x 5.4	20	70	16.0	EDL107M016A9GAA
16	20	220	8 x 10.2	20	280	35.2	EDL227M016A9MAA
16	20	330	10 x 10.2	20	380	52.8	EDL337M016A9PAA
16	20	470	10 x 10.2	20	420	75.2	EDL477M016A9PAA
25 25	32 32	4.7 10	4 x 5.4 4 x 5.4	14 20	22 24	3.0 3.0	EDL475M025A9BAA EDL106M025A9BAA
25	32	10	5 x 5.4	14	28	3.0	EDL106M025A9DAA
25	32	22	6.3 x 5.4	14	55	5.5	EDL226M025A9GAA
25	32	33	6.3 x 5.4	14	65	8.3	EDL336M025A9GAA
25	32	47	6.3 x 5.4	20	70	11.8	EDL476M025A9GAA
25 25	32 32	47	6.3 x 7.7	16 16	96	11.8	EDL476M025A9HAA
25 25	32	100 220	8 x 10.2 10 x 10.2	16	180 310	25.0 55.0	EDL107M025A9MAA EDL227M025A9PAA
35	44	2.2	4 x 5.4	12	8	3.0	EDL225M035A9BAA
35	44	3.3	4 x 5.4	12	10	3.0	EDL335M035A9BAA
35	44	4.7	4 x 5.4	12	22	3.0	EDL475M035A9BAA
35	44	10	4 x 5.4	16	24	3.5	EDL106M035A9BAA
35 35	44 44	10 22	5 x 5.4 6.3 x 5.4	12 12	30 60	3.5 7.7	EDL106M035A9DAA EDL226M035A9GAA
35	44	33	6.3 x 5.4 6.3 x 7.7	14	130	7.7 11.6	EDL226M035A9GAA EDL336M035A9HAA
35	44	47	6.3 x 7.7	14	165	16.5	EDL476M035A9HAA
35	44	100	10 x 10.2	14	210	35.0	EDL107M035A9PAA
35	44	220	10 x 10.2	14	310	77.0	EDL227M035A9PAA
50	63	1	4 x 5.4	12	10	3.0	EDL105M050A9BAA
50 50	63 63	2.2 3.3	4 x 5.4 4 x 5.4	12 12	16 16	3.0 3.0	EDL225M050A9BAA EDL335M050A9BAA
50	63	4.7	5 x 5.4	12	23	3.0	EDL475M050A9DAA
50	63	10	6.3 x 5.4	12	35	5.0	EDL106M050A9GAA
50	63	22	6.3 x 7.7	12	110	11.0	EDL226M050A9HAA
50	63	33	8 x 10.2	12	120	16.5	EDL336M050A9MAA
50	63	47	10 x 10.2	12	130	23.5	EDL476M050A9PAA
VDC	VDC Surge	Rated Capacitance	Case Size	DF	RC	LC	Part Number



# Table 1 – Ratings & Part Number Reference cont'd

VDC	VDC Surge Voltage	Rated Capacitance 120 Hz 20°C (µF)	Case Size D x L (mm)	DF 120 Hz 20°C (tan δ%)	RC 120 Hz 85°C (mA)	LC 20°C 2 Minutes (µA)	Part Number
50	63	100	10 x 10.2	12	190	50.0	EDL107M050A9PAA
63	79	4.7	8 x 10.2	18	25	3.0	EDL475M063A9MAA
63	79	10	8 x 10.2	18	25	6.3	EDL106M063A9MAA
63	79	22	8 x 10.2	18	45	13.9	EDL226M063A9MAA
63	79	33	10 x 10.2	18	45	20.8	EDL336M063A9PAA
63	79	47	10 x 10.2	18	55	29.6	EDL476M063A9PAA
100	125	3.3	8 x 10.2	18	30	3.3	EDL335M100A9MAA
100	125	4.7	8 x 10.2	18	80	4.7	EDL475M100A9MAA
100	125	10	8 x 10.2	18	85	10.0	EDL106M100A9MAA
100	125	22	10 x 10.2	18	85	22.0	EDL226M100A9PAA
100	125	33	10 x 10.2	18	90	33.0	EDL336M100A9PAA
VDC	VDC Surge	Rated Capacitance	Case Size	DF	RC	LC	Part Number



## **Mounting Positions (Safety Vent)**

In operation, electrolytic capacitors will always conduct a leakage current which causes electrolysis. The oxygen produced by electrolysis will regenerate the dielectric layer but, at the same time, the hydrogen released may cause the internal pressure of the capacitor to increase. The overpressure vent (safety vent) ensures that the gas can escape when the pressure reaches a certain value. All mounting positions must allow the safety vent to work properly.

### Installing

- A general principle is that lower-use temperatures result in a longer, useful life of the capacitor. For this reason, it should
  be ensured that electrolytic capacitors are placed away from heat-emitting components. Adequate space should be
  allowed between components for cooling air to circulate, particularly when high ripple current loads are applied. In any
  case, the maximum category temperature must not be exceeded.
- Do not deform the case of capacitors or use capacitors with a deformed case.
- Verify that the connections of the capacitors are able to insert on the board without excessive mechanical force.
- If the capacitors require mounting through additional means, the recommended mounting accessories shall be used.
- Verify the correct polarization of the capacitor on the board.
- Verify that the space around the pressure relief device is according to the following guideline:

Case Diameter	Space Around Safety Vent						
≤ 16 mm	> 2 mm						
> 16 to ≤ 40 mm	> 3 mm						
> 40 mm	> 5 mm						

It is recommended that capacitors always be mounted with the safety device uppermost or in the upper part of the capacitor.

- If the capacitors are stored for a long time, the leakage current must be verified. If the leakage current is superior to the value listed in this catalog, the capacitors must be reformed. In this case, they can be reformed by application of the rated voltage through a series resistor approximately 1 k $\Omega$  for capacitors with  $V_R \le 160$  V (5 W resistor) and 10 k $\Omega$  for the other rated voltages.
- In the case of capacitors connected in series, a suitable voltage sharing must be used.
   In the case of balancing resistors, the approximate resistance value can be calculated as: R = 60/C

KEMET recommends, nevertheless, to ensure that the voltage across each capacitor does not exceed its rated voltage.



## **Application and Operation Guidelines**

### Electrical Ratings: Capacitance (ESC)



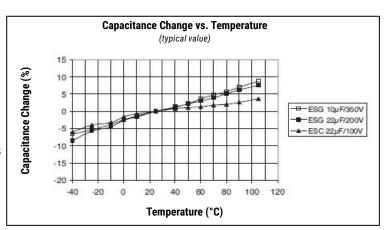
Simplified equivalent circuit diagram of an electrolytic capacitor

The capacitive component of the equivalent series circuit (Equivalent Series Capacitance ESC) is determined by applying an alternate voltage of  $\leq 0.5$  V at a frequency of 120 or 100 Hz and 20°C (IEC 384-1, 384-4).

#### **Temperature Dependence of the Capacitance**

Capacitance of an electrolytic capacitor depends upon temperature: with decreasing temperature the viscosity of the electrolyte increases, thereby reducing its conductivity.

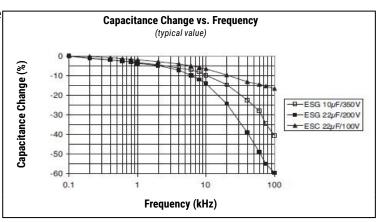
Capacitance will decrease if temperature decreases. Furthermore, temperature drifts cause armature dilatation and, therefore, capacitance changes (up to 20% depending on the series considered, from 0 to 80°C). This phenomenon is more evident for electrolytic capacitors than for other types.



#### **Frequency Dependence of the Capacitance**

Effective capacitance value is derived from the impedance curve, as long as impedance is still in the range where the capacitance component is dominant.

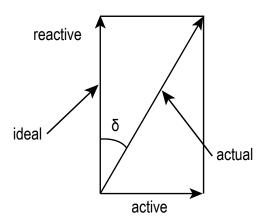
$$C = \frac{1}{2\pi \text{ fZ}} \frac{\text{C = Capacitance (F)}}{\text{f = Frequency (Hz)}}$$
$$Z = \text{Impedance ($\Omega$)}$$





### Dissipation Factor $\tan \delta$ (DF)

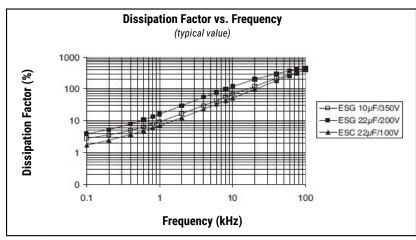
Dissipation Factor  $\tan \delta$  is the ratio between the active and reactive power for a sinusoidal waveform voltage. It can be thought of as a measurement of the gap between an actual and ideal capacitor.

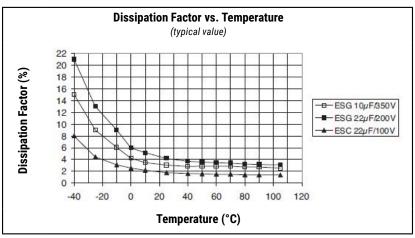


Tan  $\delta$  is measured with the same set-up used for the series capacitance ESC. tan  $\delta$  =  $\omega$  x ESC x ESR where:

ESC = Equivalent Series Capacitance

ESR = Equivalent Series Resistance



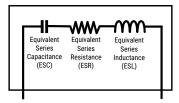




### **Equivalent Series Inductance (ESL)**

Equivalent Series Inductance or Self Inductance results from the terminal configuration and internal design of the capacitor.



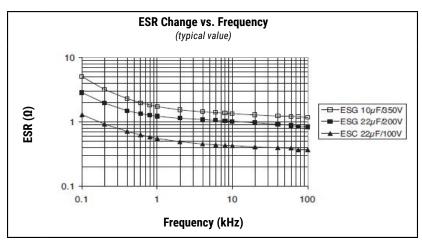


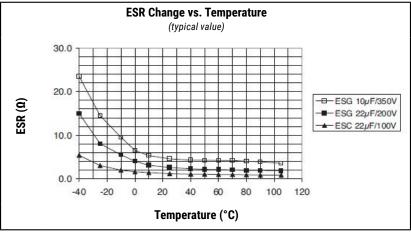
#### **Equivalent Series Resistance (ESR)**

Equivalent Series Resistance is the resistive component of the equivalent series circuit. ESR value depends on frequency and temperature and is related to the tan  $\delta$  by the following equation:

$$ESR = \frac{\tan \delta}{2\pi f \ ESC} \ \frac{\text{ESR} = Equivalent Series Resistance } {\tan \delta = Dissipation \ Factor} \\ ESC = Equivalent Series Capacitance (F) \\ f = Frequency (Hz)$$

Tolerance limits of the rated capacitance must be taken into account when calculating this value.

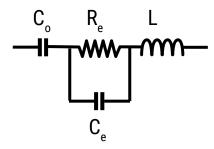






#### Impedance (Z)

Impedance of an electrolytic capacitor results from a circuit formed by the following individual equivalent series components:



 $C_{_{\alpha}}$  = Aluminum oxide capacitance (surface and thickness of the dielectric)

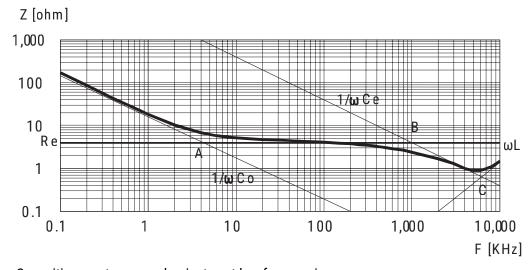
R<sub>a</sub> = Resistance of electrolyte and paper mixture (other resistances not depending on the frequency are not considered: tabs, plates, etc.)

C<sub>a</sub> = Electrolyte soaked paper capacitance

L = Inductive reactance of the capacitor winding and terminals

Impedance of an electrolytic capacitor is not a constant quantity that retains its value under all conditions; it changes depending on frequency and temperature.

Impedance as a function of frequency (sinusoidal waveform) for a certain temperature can be represented as follows:



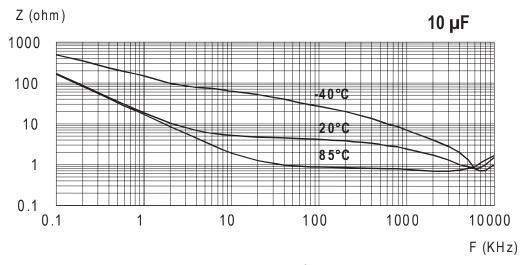
- Capacitive reactance predominates at low frequencies
- With increasing frequency, capacitive reactance  $Xc = 1/\omega C_0$  decreases until it reaches the order of magnitude of electrolyte resistance R<sub>a</sub>(A)
- At even higher frequencies, resistance of the electrolyte predominates: Z = R<sub>a</sub> (A B)
- When the capacitor's resonance frequency is reached  $(\omega_0)$ , capacitive and inductive reactance mutually cancel each other  $1/\omega C_{o} = \omega L, \omega_{o} = C\sqrt{1/LCe}$
- Above this frequency, inductive reactance of the winding and its terminals ( $XL = Z = \omega L$ ) becomes effective and leads to an increase in impedance

Generally speaking, it can be estimated that  $C_p \approx 0.01 C_0$ .



#### Impedance (Z) cont'd

Impedance as a function of frequency (sinusoidal waveform) for different temperature values can be represented as follows (typical values):



R is the most temperature-dependent component of an electrolytic capacitor equivalent circuit. Electrolyte resistivity will decrease if temperature rises.

In order to obtain a low impedance value throughout the temperature range, R<sub>o</sub> must be as little as possible. However, R<sub>o</sub> values that are too low indicate a very aggressive electrolyte, resulting in a shorter life of the electrolytic capacitor at high temperatures. A compromise must be reached.

#### Leakage Current (LC)

Due to the aluminum oxide layer that serves as a dielectric, a small current will continue to flow even after a DC voltage has been applied for long periods. This current is called leakage current.

A high leakage current flows after applying voltage to the capacitor then decreases in a few minutes, e.g., after prolonged storage without any applied voltage. In the course of continuous operation, the leakage current will decrease and reach an almost constant value.

After a voltage-free storage the oxide layer may deteriorate, especially at high temperature. Since there are no leakage currents to transport oxygen ions to the anode, the oxide layer is not regenerated. The result is that a higher than normal leakage current will flow when voltage is applied after prolonged storage.



#### Leakage Current (LC) cont'd

As the oxide layer is regenerated in use, the leakage current will gradually decrease to its normal level.

The relationship between the leakage current and voltage applied at constant temperature can be shown schematically as follows:



#### V<sub>r</sub> = Forming voltage

If this level is exceeded, a large quantity of heat and gas will be generated and the capacitor could be damaged.

### V<sub>D</sub> = Rated Voltage

This level represents the top of the linear part of the curve.

### V<sub>c</sub> = Surge voltage

This lies between  $V_R$  and  $V_F$ . The capacitor can be subjected to  $V_S$  for short periods only.

Electrolytic capacitors are subjected to a reforming process before acceptance testing. The purpose of this preconditioning is to ensure that the same initial conditions are maintained when comparing different products.



The maximum ripple current value depends on:

- Ambient temperature
- Surface area of the capacitor (heat dissipation area)

 $tan \delta or ESR$ 

Frequency

The capacitor's life depends on the thermal stress.

#### **Frequency Dependence of the Ripple Current**

ESR and, thus, the tan  $\delta$  depend on the frequency of the applied voltage. This indicates that the allowed ripple current is also a function of the frequency.

#### **Temperature Dependence of the Ripple Current**

The data sheet specifies maximum ripple current at the upper category temperature for each capacitor.

#### **Expected Life Calculation**

Expected life depends on operating temperature according

to the following formula:  $L = Lo \times 2^{(To-T)/10}$ 

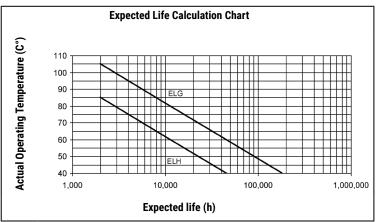
Where:

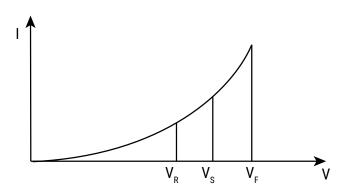
L: Expected life

Load life at maximum permissible operating Lo: temperature

T: Actual operating temperature

Maximum permissible operating temperature To: This formula is applicable between 40°C and To.



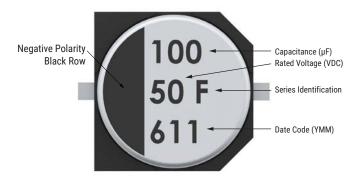




## **Packaging Quantities**

Size Code	Diameter (mm)	Length (mm)	Reel Quantity	Box Quantity (4 Reels per box)
9B	4	5.4	2000	10000
9D	5	5.4	1000	10000
9G	6.3	5.4	1000	10000
9H	6.3	7.7	1000	10000
9M	8	10.2	500	4000
9P	10	10.2	500	4000

# **Standard Marking for Surface Mount Types**



Note: 6.3 V rated voltage shall be marked as 6 V, but 6.3 V shall be assured.

\*Y = Year

	-									
Code	0	1	2	3	4	5	6	7	8	9
Year	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019

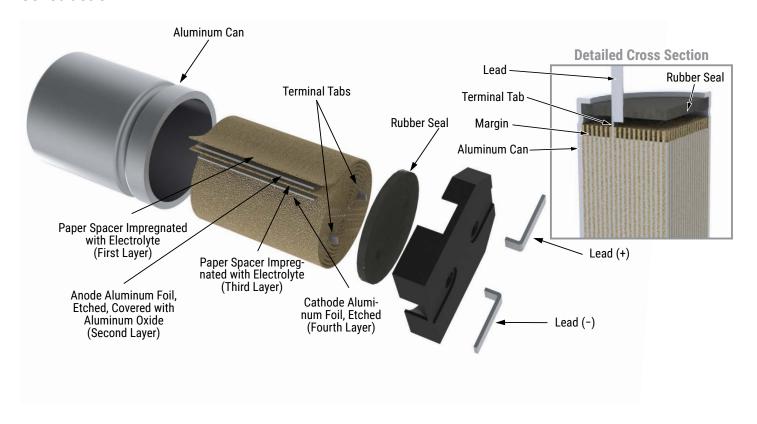
M = Month

Code	1	2	3	4	5	6	7	8	9	Α	В	С
Month	1	2	3	4	5	6	7	8	9	10	11	12

M = Manufacturing internal code



### **Construction**

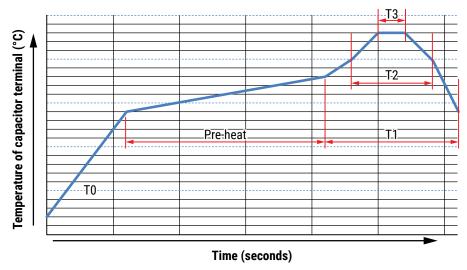




## **Soldering Process**

The soldering conditions should be within the specified conditions below:

Do not dip the capacitors body into the melted solder. Flux should only be applied to the capacitors terminals



Vapour heat transfer systems are not recommended. The system should be thermal, such as infra-red radiation or hot blast Observe the soldering conditions as shown below. Do not exceed these limits and avoid repeated reflowing

## **Reflow Soldering**

	Temperature (°C)	Maximum Time (Seconds)			
T0	20 to 140	60			
Pre-heat	140 to 180	150			
T1	180 to 140	100			
T2	> 200	60			
Т3	230	20			

# **Lead Free Reflow Soldering**

	Temperature (°C)	Maximum Time (Seconds)			
T0	20 to 160	60			
Pre-heat	160 to 190	120			
T1	190 to 180	90			
T2	> 220	60			

## Lead Free Reflow Soldering cont'd.

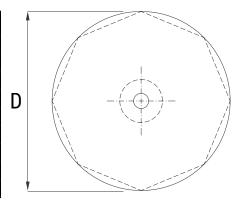
Т3	Size	Temperature (°C)	Maximum Time (Seconds)		
	Φ4 ~ Φ5 (4 - 50 V)	250	10		
	Ψ4 ~ Ψ3 (4 - 30 V)	260	5		
	Φ6.3 ~ Φ10 (4 - 50 V)	250	5		
	Ф4 ~ Ф10 (63 - 100 V)	250	5		

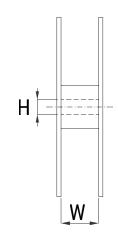
	Size	Temperature (°C)	Maximum Time (Seconds)		
	Ф4 ~ Ф5	250	10		
	(4 - 50 V)	260	5		
Т3	Ф6.3 ~ Ф10 (4 - 50 V)	250	5		
	Φ4 ~ Φ10 (63 - 100 V)	250	5		
	≥ Ф12.5	250	5		



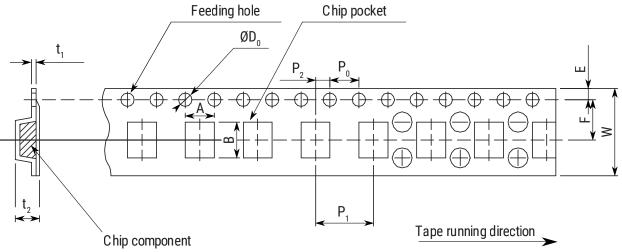
## **Lead Taping & Packaging**

	Reel						
Case Size (mm)	D	Н	<b>W</b> ±1.0				
	±0.2	±0.8					
4 x 5.4		21	14				
5 x 5.4		21	14				
6.3 x 5.4		21	18				
6.3 x 7.7	380	21	18				
8 x 6.2		21	18				
8 x 10.2		21	26				
10 x 10.2		21	26				





# **Taping for Automatic Insertion Machines**



Dimensions (mm)	W	A	В	P0	P1	P2	F	D0	E	t1	t2
Tolerance	Nominal	Nominal	Nominal	±0.1	±0.1	±0.1	Nominal	±0.1	Nominal	Nominal	Nominal
4 x 5.4	12	4.7	4.7	4	8	2	5.5	1.5	1.75	0.4	5.8
5 x 5.4	12	5.7	5.7	4	12	2	5.5	1.5	1.75	0.4	5.8
6.3 x 5.4	16	7	7	4	12	2	7.5	1.5	1.75	0.4	5.8
6.3 x 7.7	16	7	7	4	12	2	7.5	1.5	1.75	0.4	5.8
8 x 6.2	16	8.7	8.7	4	12	2	7.5	1.5	1.75	0.4	6.8
8 x 10.2	24	8.7	8.7	4	16	2	11.5	1.5	1.75	0.4	11
10 x 10.2	24	10.7	10.7	4	16	2	11.5	1.5	1.75	0.4	11
12.5 x 13.5	32	13.4	13.4	4	24	2	14.2	1.5	1.75	0.5	14
12.5 x 16	32	13.4	13.4	4	24	2	14.2	1.5	1.75	0.5	17.5
16 x 16.5	44	17.5	17.5	4	28	2	20.2	1.5	1.75	0.5	17.5



#### **Construction Data**

The manufacturing process begins with the anode foil being electrochemically etched to increase the surface area and then "formed" to produce the aluminum oxide layer. Both the anode and cathode foils are then interleaved with absorbent paper and wound into a cylinder. During the winding process, aluminum tabs are attached to each foil to provide the electrical contact.

The deck, complete with terminals, is attached to the tabs and then folded down to rest on top of the winding. The complete winding is impregnated with electrolyte before being housed in a suitable container, usually an aluminum can, and sealed. Throughout the process, all materials inside the housing must be maintained at the highest purity and be compatible with the electrolyte.

Each capacitor is aged and tested before being sleeved and packed. The purpose of aging is to repair any damage in the oxide layer and thus reduce the leakage current to a very low level. Aging is normally carried out at the rated temperature of the capacitor and is accomplished by applying voltage to the device while carefully controlling the supply current. The process may take several hours to complete.

Damage to the oxide layer can occur due to variety of reasons:

- Slitting of the anode foil after forming
- Attaching the tabs to the anode foil
- Minor mechanical damage caused during winding

A sample from each batch is taken by the quality department after completion of the production process. This sample size is controlled by the use of recognized sampling tables defined in BS 6001.

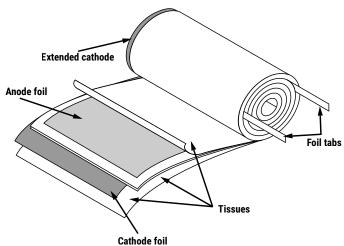
The following tests are applied and may be varied at the request of the customer. In this case the batch, or special procedure, will determine the course of action.

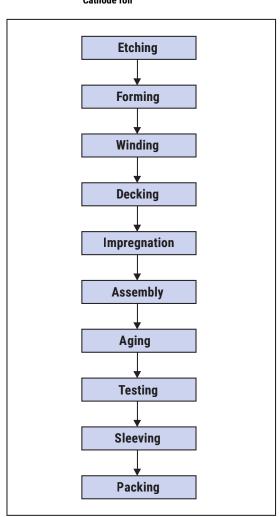
#### Electrical:

- · Leakage current
- Capacitance
- ESR
- Impedance
- · Tan Delta

#### Mechanical/Visual:

- Overall dimensions
- Torque test of mounting stud
- Print detail
- Box labels
- Packaging, including packed quantity







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Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.